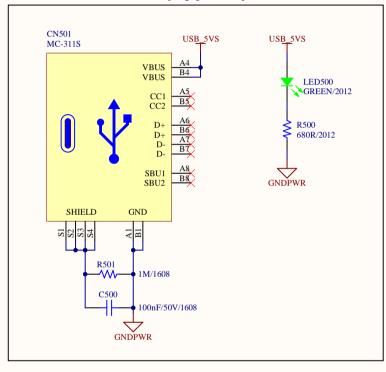


1 2 3

TPS65217 Test B'd (Rev.A)

# [5] Connector

## USB Connector (Type-C)

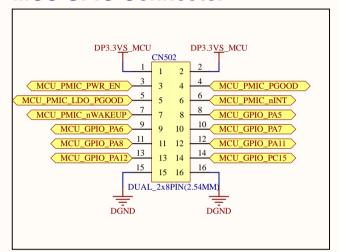


H503

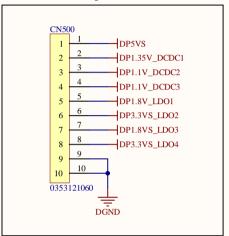
NTH-3MM

NTH-3MM

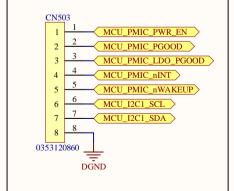
#### **MCU GPIO Connector**

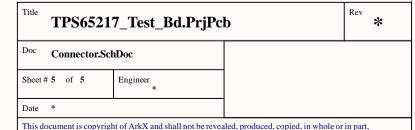


### **PMIC Output Rails**



## **PMIC Status Signals**





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С

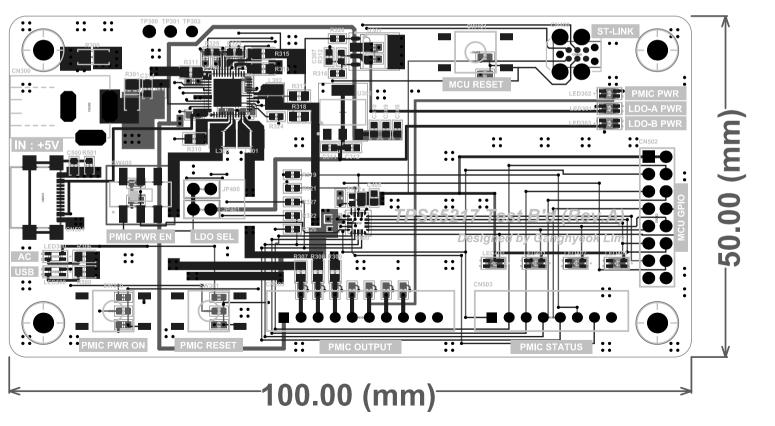
В

D

**Mount Holes** 

NTH-3MM

NTH-3MM



# Layer Information			
L1	Top (Signal / GND)		
L2	GND		
L3	Power		
L4	Signal / GND		
L5	GND		
L6	Bottom (Signal / GND)		

# PCB Specification (JLCPCB)			
No	Category	Selection	
1	Base Material	FR-4	
2	Layer #	6 - Layer	
3	Dimension	220(mm) * 160(mm)	
4	Thickness	1.6T	
5	Color	Black	
6	Material Type	FR-4 TG155	
7	Surface Finish	ENIG	
8	Gold Thickness	2 U"	
9	Outer Copper Weight	1 oz	
10	Inner Copper Weight	0.5 oz	
11	Impedance Control	No	
12	Layer Stack-up	Default	
13	Via Covering	Epoxy Filled & Capped	
14	Min. Via Hole Size / Diameter	Hole: 0.2mm / Diameter: 0.35mm	
15	Board Outline Tolerance	±0.2mm (Regular)	
16	Confirm Production File	No	
17	Remove Order Number	Yes	
18	Flying Probe Test	Fully Test	
19	Gold Fingers	No	
20	30° Finger Chamfered	No	
21	Castellated Holes	No	
22	Edge Plating	No	